ALLEVIATION OF STRESS CONCENTRATION WITH ANALOGUE REINFORCEMENT

by

Toshiaki Chiba

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APPROVED:

R. A. Heller, Chairman

D. Frederick

H. F. Brinson

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LIST OF SYMBOLS

σ _r , σ _θ , τ _{rθ}	Stress components in polar coordinates
σ , ^σy, ^τxy	Stress components in cartesian coordinates
^σ ι, ^σ 2	Principal stresses
σ _a	Average stress applied at the end of the plate
σ0	Average stress on the transverse section of symmetry through a hole
a, b	Radius of hole and half width of the plate, respectively
r, θ	Polar coordinates
^K t	Stress concentration factor in tension
f	Material fringe value
n	Fringe order
t	Plate thickness
α	Angle between principal direction and X axis
ф	Airey's stress function
R ₁ , R ₂	Inner and outer radii of a reinforcing ring, respectively
^h 1, ^h 2	Total thickness of reinforced and unreinforced plate, respectively
E _L , E _T	Elastic moduli in the longitudinal and transverse directions, respectively
ν _{LT}	Poisson's ratio
GLT	Shear modulus

1. INTRODUCTION

Several researchers have investigated the problem of reducing stress concentration around a hole in a plate. The most frequently utilized technique involves the use of a bead or a reinforcing ring around the hole.

Recent interest in filamentary composites has focused attention on the possibilities of improving the distribution of stresses with variations of the density, stiffness and orientation of fibers in the immediate vicinity of a stress raiser.

With this viewpoint in mind reinforced plates were constructed in which the reinforcement was placed either in the form of a rectangular grid or along an orthogonal set of lines following stress trajectories in the plate.

The reinforcement in these specimens consisted of a photo-etched brass grid sandwiched between two sheets of a birefringent material.

Stress concentration factors were then determined photoelastically and were compared with theoretical and experimental values for isotropic homogeneous plates as well with published experimental results for fiber reinforced and bead reinforced plates.

A substantial reduction of the stress concentration factor was observed in plates containing the "analogue" reinforcement (fibers following stress trajectories).

2. LITERATURE REVIEW

Determination of stress concentration at the edge of a hole is of great practical importance in engineering structures.

The analytical solution of this problem may be traced to the solution of the stress distribution in an infinite plate with a hole under a uniform load first published by Kirsch [1] in 1898. According to that paper,

$$\sigma_{r} = \frac{\sigma_{a}}{2} \left(1 - \frac{a^{2}}{r^{2}}\right) + \frac{\sigma_{a}}{2} \left(1 - \frac{4a^{2}}{r^{2}} + \frac{3a^{4}}{r^{4}}\right) \cos 2\theta$$

$$\sigma_{\theta} = \frac{\sigma_{a}}{2} \left(1 + \frac{a^{2}}{r^{2}}\right) - \frac{\sigma_{a}}{2} \left(1 + \frac{3a^{4}}{r^{4}}\right) \cos 2\theta \qquad (1-1)$$

$$\tau_{r\theta} = -\frac{\sigma_{a}}{2} \left(1 + \frac{2a^{2}}{r^{2}} - \frac{3a^{4}}{r^{4}}\right) \sin 2\theta ,$$

with the notation shown in Fig. 1. As noted by Timoshenko and Goodier [2], this solution has been well confirmed many times by strain measurements and by photoelastic experiments.

In 1930, Howland [3] extended the solution to the more general case. In his work, the plate was assumed to be bounded by two parallel edges, with a hole midway between these edges. The analysis was developed for the case of a stress system symmetrical with respect to the longitudinal axis of the strip and to the diameter of the hole perpendicular to the axis. The solution of the uniaxial tension problem was then obtained by successive approximations.

From Eq. (1-1), it is seen that σ_{θ} is greatest when $\theta = \pi/2$ or $\theta = 3\pi/2$, i.e., at the ends m and n of the diameter perpendicular to the direction of the applied force. At these points $(\sigma_{\theta})_{max} = 3\sigma_{a}$. This is the maximum tensile stress and is three times the uniform stress σ_{a} , applied at remote point from the hole.

The stress concentration factor is defined as the ratio of the maximum stress and the remote, uniform stress,

$$K_{t} = \frac{\sigma_{max}}{\sigma_{a}}, \qquad (1-2)$$

For an infinite plate with a hole under uniform tension, $K_t = 3$. It is often necessary to reduce the stress concentration around holes in structures. This can be done by adding a bead or reinforcing ring to the plate. An approximate solution for this problem was given as early as 1924, by Timoshenko [4], who treated the reinforcement as a curved bar. The method is applicable to reinforcement of arbitrary cross section, provided its cross-sectional dimensions are small compared with the radius of the hole.

In 1932, Sezawa and Kubo [5] published a plane-stress solution for reinforcement by a symmetrical circular doubler in which the reinforced plate is replaced by an equivalent plate of constant thickness but with the elastic modulus larger within the doubler than through the rest of the plate. In 1938, another solution for reinforcement by a symmetrical circular doubler was published by Gurney [6]. Gurney's solution proceeds from the known general plane-stress solution for an

infinite plate with a circular hole and adjusts the arbitrary constants in the solution to satisfy equilibrium of forces and continuity of displacements at the outer edge of the reinforcement. An extension of Gurnev's solution to include the additional effect of a flange around the edge of the hole was given in 1944, by Beskin [7]. In Beskin's solution, the stresses in the doubler and the plate are computed from plane-stress theory on the assumption that the flange at the edge of the hole carries circumferential stresses only. The solutions either require the reinforcement to be concentrated near the edge of the hole (Timoshenko, Beskin), or require the reinforcement to be of constant thickness (Sezawa and Kubo, Gurney). In 1948, an analysis of radially symmetrical reinforcements of variable thickness was given by Levy, McPherson and Smith [8] for the case in which the load is uniform tension in all directions. In 1955, Radok [9] presented a two-dimensional solution for the elastic equilibrium of an infinite thin plate with a compactly reinforced hole. Radok's work utilized the general techniques developed by Muskhelishvili [10] for the solution of two dimensional elasto-static problems and represented a concise, direct method applicable to any hole which could be mapped conformally onto the unit circle by use of polynomials or rational functions.

In the field of experimental research, Shimada [11] reported the stress distributions in epoxy-resin bars with reinforced circular holes under pure tension. The holes were reinforced by bonding aluminum rings to the bars inside the holes as shown in Fig. 2(a). Various proportions of circular reinforcements and different width of bars were investigated,

and the stress distributions were determined photoelastically in the epoxy-resin part of the bar. Suzuki [12] measured the stress distributions photoelastically along the inner surface of a ring under uniform tension. He used materials with nearly equal Young's moduli in the plate and the ring. Thus, the specimen was considered to be one solid body. His reinforcing rings are shown in Fig. 2(b). In 1969, the same author, Suzuki [13], investigated the stress distribution around a reinforced circular hole, Fig. 2(b), in an infinite plate subjected to uniaxial tension. Plates were made of aluminum with reinforcing rings of aluminum, brass, copper and mild steel. The stresses were obtained by least-square method and stress concentration factors were decided. Additional work for the determination of the stress distribution around a circular hole was performed in 1964 and 1967 by Seika [14],[15]. His reinforcing rings are shown in Figs. 2(c) and (d). To determine the stress distribution, he used the photoelastic stress freezing method.

Recently, studies of fiber reinforced composite materials have been investigated. Daniel and Rowlands [16] determined the strain and the stress concentration factor by the moiré technique. The specimens used in their investigation were 7-ply glass-epoxy laminates of $[90/0/90/\overline{0}]_{s}$ layup, with approximately 0.45 volume fraction of fibers (Scotchply 1002, 3M Company). The specimens were 4 in. wide and 0.067 in. thick with central circular holes of 0.50 in., 0.75 in., and 1.00 in. diameter. These specimens were loaded in tension in increments of 300 lbs. up to levels of 2,700 and 3,900 lb. The results of this investigation will be discussed in Chapter 4.

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When a composite under various loading conditions is considered, discussions shift from a material to a structural viewpoint. Since a composite is a combination of materials selected to obtain specified design objectives, a structural mechanics approach is essential. If the roles of the constituent elements of a composite are reconsidered, new approaches to reducing stress concentrations may be found.

As noted by Gerard [17], in 1967, a laminate can be designed to carry an alternate load system in addition to the basic biaxial load $(N_1 \text{ and } N_2)$ for which it was primarily designed. He also suggested that one could pose the design question: given a filamentary bilayer laminate designed for the principal stress resultants N_1 and N_2 , what are other possible load combinations that the laminate can carry?

In 1969, two years after Gerard's suggestion, Hyman [18] reported exploratory test results on fiber reinforced plate with circular holes under tension in which the reinforcement was supposed to approximate the directions of principal stress resultants. Since the plates, as shown in Fig. 3, were fabricated by simply separating the fibers around the hole, their orientation did not really coincide with the orientation of the principal stress resultants. Hyman's results will be discussed in Chapter 4.

Lackman and Ault [19] investigated the effects of fiber orientation on the stress distribution around a cut-out in a filamentary composite plate. Using a finite element analysis they have concluded that varying the direction and shape of the reinforcement results in a significant reduction of the stress concentration. They examined plates with

rectangular cut-outs and lugs with circular holes. Since they limited their choices of reinforcement to 0° , $0-90^{\circ}$ and isotropic stiffening, comparisons with the present investigation are only qualitative.

3. THE EXPERIMENT

Specimens used in this investigation were made by sandwiching brass reinforcement between two birefringent plates. Depending on the type of reinforcement, these specimens are classified into two categories. The first type of reinforcement follows the stress trajectories of an infinite plate with a half inch hole, while the second type consists of a rectangular grid of straight lines.

It is difficult to produce such reinforcement by punching techniques or other mechanical means. Mechanical techniques can result in various side effects, such as residual stresses or excessive deformations especially when very thin, very brittle, or very soft materials are being processed. With chemical milling and Kodak "photosensitive resists" [20],[21], these problems are greatly reduced. For this reason, a photofabrication method was used to shape the reinforcement into the desired configurations.

3.1 Determination of Stress Trajectories

The stress distribution for an infinite plate with a hole under an uniaxial tensile load is expressed in cylindrical coordinates as shown in Eqs. (1-1). In order to determine the stress trajectories, Eqs. (1-1) are expressed in rectangular cartesian form.

A thin plate under a uniaxial tensile load, as shown in Fig. 1, will be analyzed. If the width, 2b, of the plate is large in comparison with the radius, a, of the hole, the stresses at a radius, b, are

effectively the same as in the plate without the hole and are therefore given by

$$(\sigma_{r})_{r=b} = \sigma_{a} \cos^{2}\theta = \frac{1}{2}\sigma_{a}(1 + \cos^{2}\theta)$$

$$(3-1)$$

$$(\tau_{r\theta})_{r=b} = -\frac{1}{2}\sigma_{a} \sin^{2}\theta$$

These forces, acting around the outside of the ring having inner and outer radii r = a and r = b respectively, produce a stress distribution within the ring which may be regarded as consisting of two parts. The first part is due to the constant component $\frac{1}{2}\sigma_a$ of the uniaxial forces. The remaining part consists of the normal force $\frac{1}{2}\sigma_a$ cos20, together with the shearing force $-\frac{1}{2}\sigma_a \sin 2\theta$.

First the stresses produced by the uniform tension, $\frac{1}{2}\sigma_a$, acting on the outer boundary (r = b) will be determined. Since the z axis normal to the plane of the plate is a symmetry axis, the stress function in this case is given by (2)

$$\phi_1 = A \log r + Br^2 \log r + Cr^2 + D$$
, (3-2)

where A, B, C and D are constants of integration. Because of axial symmetry, all derivatives with respect to θ are zero, and consideration of finite displacements requires, for a unique solution, that B = 0. Hence, the stress function for the case of no internal forces becomes

$$\phi_1 = -\frac{a^2 b^2 \sigma_a}{2(b^2 - a^2)} \log r + \frac{b^2 r^2 \sigma_a}{4(b^2 - a^2)}.$$
 (3-3)

Since $r^2 = x^2 + y^2$, the stress function, ϕ_1 , can be written in cartesian coordinate form as

$$\phi_1 = -\frac{a^2b^2\sigma_a}{2(b^2 - a^2)}\log(x^2 + y^2)^{1/2} + \frac{b^2\sigma_a}{4(b^2 - a^2)}(x^2 + y^2) . \quad (3-4)$$

Putting a/b = 0, for the infinitely large plate,

$$\phi_1 = -\frac{a^2\sigma_a}{2}\log(x^2+y^2)^{1/2}+\frac{\sigma_a}{4}(x^2+y^2)$$
. (3-5)

The stress components are given by

$$\sigma_{\mathbf{x}} = \frac{\partial^2 \phi}{\partial \mathbf{y}^2}, \qquad \sigma_{\mathbf{y}} = \frac{\partial^2 \phi}{\partial \mathbf{x}^2}, \qquad \tau_{\mathbf{x}\mathbf{y}} = -\frac{\partial^2 \phi}{\partial \mathbf{x} \partial \mathbf{y}}.$$
 (3-6)

The stress components due to the uniform tension $\frac{1}{2}\sigma_a$ on the outer boundary can be obtained from Eqs. (3-5) and (3-6)

$$\sigma_{x}^{+} = -\frac{a^{2}\sigma_{a}}{2} \frac{x^{2} - y^{2}}{(x^{2} + y^{2})^{2}} + \frac{\sigma_{a}}{2}$$

$$\sigma_{y}^{+} = -\frac{a^{2}\sigma_{a}}{2} \frac{y^{2} - x^{2}}{(x^{2} + y^{2})^{2}} + \frac{\sigma_{a}}{2}$$

$$\tau_{xy}^{+} = -\frac{a^{2}\sigma_{a}xy}{(x^{2} + y^{2})^{2}}$$
(3-7)

The stress function for the second case, i.e., normal force $\frac{1}{2}\sigma_a$ cos20 and shearing force $-\frac{1}{2}\sigma_a$ sin20 on the outer boundary (r = b) is (2)

$$\phi_2 = -\frac{\sigma_a}{4} \left[r^2 + \frac{a^4}{r^2} - 2a^2\right] \cos 2\theta$$
 (3-8)

Changing the stress function, ϕ_2 , into rectangular cartesian form by using the relationships

$$r^{2} = x^{2} + y^{2}$$
 and $\cos 2\theta = \cos^{2}\theta - \sin^{2}\theta = \frac{x^{2} - y^{2}}{x^{2} + y^{2}}$,

and after setting a/b + 0, ϕ_2 can be written as

$$\phi_2 = -\frac{\sigma_a}{4} \left[x^2 - y^2 + \frac{a^4(x^2 - y^2)}{(x^2 + y^2)^2} - \frac{2a^2(x^2 - y^2)}{x^2 + y^2} \right]$$
(3-9)

From Eqs. (3-6) and (3-9), the stress components then become

$$\sigma_{\mathbf{x}}^{"} = \frac{\sigma_{\mathbf{a}}}{2} \left[1 + \frac{a^{4}(3x^{2} - y^{2})}{(x^{2} + y^{2})^{3}} - \frac{4a^{2}x^{2}}{(x^{2} + y^{2})^{2}} - \frac{4a^{4}y^{2}(5x^{2} - y^{2})}{(x^{2} + y^{2})^{4}} + \frac{16a^{2}x^{2}y^{2}}{(x^{2} + y^{2})^{3}}\right]$$

$$\sigma_{\mathbf{y}}^{"} = -\frac{\sigma_{\mathbf{a}}}{2} \left[1 - \frac{a^{4}(x^{2} - 3y^{2})}{(x^{2} + y^{2})^{3}} - \frac{4a^{2}y^{2}}{(x^{2} + y^{2})^{2}} + \frac{4a^{4}x^{2}(x^{2} - 5y^{2})}{(x^{2} + y^{2})^{4}} + \frac{16a^{2}x^{2}y^{2}}{(x^{2} + y^{2})^{3}}\right]$$

$$\tau_{\mathbf{xy}}^{"} = 2a^{2}xy\sigma_{\mathbf{a}}\left[\frac{x^{2} - y^{2}}{(x^{2} + y^{2})^{3}}\right]\left[\frac{3a^{2}}{(x^{2} + y^{2})} - 2\right]$$
(3-10)

The total solution for the infinite plate with a hole under a uniaxial tensile load can be obtained by adding Eqs. (3-7) and (3-10)

$$\sigma_{x} = \frac{\sigma_{a}}{2} \left[2 - \frac{a^{2}(5x^{2} - y^{2})}{(x^{2} + y^{2})^{2}} + \frac{a^{4}(3x^{2} - y^{2})}{(x^{2} + y^{2})^{3}} + \frac{16a^{2}x^{2}y^{2}}{(x^{2} + y^{2})^{3}} - \frac{4a^{4}y^{2}(5x^{2} - y^{2})}{(x^{2} + y^{2})^{4}} \right]$$

$$\sigma_{y} = \frac{\sigma_{a}}{2} \left[\frac{a^{2}(3y^{2} + x^{2})}{(x^{2} + y^{2})^{2}} + \frac{a^{4}(x^{2} - 3y^{2})}{(x^{2} + y^{2})^{3}} - \frac{16a^{2}x^{2}y^{2}}{(x^{2} + y^{2})^{3}} - \frac{4a^{4}x^{2}(x^{2} - 5y^{2})}{(x^{2} + y^{2})^{4}} \right]$$

$$\tau_{xy} = 2a^{2}xy\sigma_{a} \left\{ \left[\frac{x^{2} - y^{2}}{(x^{2} + y^{2})^{3}} \right] \left(\frac{3a^{2}}{x^{2} + y^{2}} - 2 \right) - \frac{1}{2(x^{2} + y^{2})^{2}} \right\}$$
(3-11)

Eqs. (3-11) satisfy the following boundary conditions,

$$\sigma_{x}\Big|_{\substack{x=a \ y=0}} = 0, \quad \sigma_{x}\Big|_{\substack{x=b \ y=0}} = S, \quad \sigma_{x}\Big|_{\substack{x=0 \ y=a}} = 3S$$
(3-12)

$$\sigma_{\mathbf{y}} \begin{vmatrix} \mathbf{z} = \mathbf{0}, & \sigma_{\mathbf{y}} \end{vmatrix} = \mathbf{0}, & \sigma_{\mathbf{y}} \begin{vmatrix} \mathbf{z} = \mathbf{0}, & \sigma_{\mathbf{y}} \end{vmatrix} = -S \\ \mathbf{x} = \mathbf{0}, & \mathbf{y} = \mathbf{b}, & \mathbf{y} \end{vmatrix} = \mathbf{0},$$

 $\tau_{xy} = 0$ at x = 0 or y = 0.

To check the above results the following stress invariants were used

$$I = \sigma_{x} + \sigma_{y} + \sigma_{z}$$

$$II = \sigma_{x}\sigma_{y} + \sigma_{y}\sigma_{z} + \sigma_{x}\sigma_{z} - \tau_{xy}^{2} - \tau_{yz}^{2} - \tau_{xz}^{2}$$

$$III = \sigma_{x}\sigma_{y}\sigma_{z} + 2\tau_{xy}\tau_{yz}\tau_{xz} - \sigma_{x}\tau_{yz}^{2} - \sigma_{y}\tau_{xz}^{2} - \sigma_{z}\tau_{xy}^{2}$$

$$(3-13)$$

Eqs. (1-1) and Eqs. (3-11) were compared with the aid of Eqs. (3-13).

Principal stress directions in a two dimensional state of stress are given by [22]

$$\tan 2\alpha = \frac{2\tau_{xy}}{\sigma_x - \sigma_y}$$
(3-14)

where α is the angle between the principal direction and the x axis. Since

$$\tan 2\alpha = \frac{2\tan\alpha}{1 - \tan^2\alpha},$$
$$\frac{2\tan\alpha}{1 - \tan^2\alpha} = \frac{2\tau_{xy}}{\sigma_x - \sigma_y}$$

Hence,

$$\tau_{xy} \tan^2 \alpha + (\sigma_x - \sigma_y) \tan \alpha - \tau_{xy} = 0 \qquad (3-15)$$

Solving this quadratic equation with respect to $tan\alpha$, the slope of the stress trajectories is obtained:

$$\tan \alpha = \frac{dy}{dx} = \frac{1}{\tau_{xy}} \left[-\left(\frac{\sigma_x - \sigma_y}{2}\right) \pm \sqrt{\left(\frac{\sigma_x - \sigma_y}{2}\right)^2 + \tau_{xy}^2} \right] .$$
(3-16)

In this equation, $\sigma_{\chi}^{},\,\sigma_{y}^{}$ and $\tau_{\chi y}^{}$ are given by Eqs. (3-11).

From Eqs. (3-11) and (3-16) it is obvious that Eq. (3-16) is independent of the average stress σ_a . Therefore, Eqs. (3-11) were used without σ_a .

To determine the stress trajectories, consisting of a family of orthogonal lines, the first order ordinary differential equation, Eq. (3-16), was first integrated numerically with a positive sign before the root and subsequently with a negative sign. The above integration was carried numerically by computer using a subroutine RKGS, which uses a Runge-Kutta method for an approximate solution of a system of first order ordinary differential equations with given initial values.

The numerical calculation was performed for a plate with a hole radius, a, of 0.5 in. Lower and upper bounds of the integration intervals for the independent variable were set at -2.5 and -0.001 respectively, and the initial increment of the independent variable was 0.125. The starting point for the dependent variable was set at 0.125 and its increment was 0.125.

The computed spacing of the stress trajectories is twice as large as the actual spacing of the reinforcement. As will be explained in section 3.2 the desired size of reinforcement was obtained by a photographic reduction.

3.2 Photofabrication Method

In engineering applications or in consumer markets, the concepts of photofabrication are widely used. This photofabrication is a unique process by which parts can be produced through the use of photography and photosensitive materials called "resists".

This technique of photofabrication can be broken down into the following series of steps:

- i. Preparation of the artwork.
- ii. Photography of the artwork with a suitable camera to make a photographically reduced working image of the desired pattern.
- iii. Exposure of a photoresist-coated surface, using the photographically reduced negative.
 - iv. Development of the exposed photoresist in the proper developer.
 - v. Etching of the surface.

Kodak photosensitive resists (KPR) are liquid formulations of resins. When applied to a material surface and allowed to dry, they become sensitive to relatively short exposures of ultraviolet radiation. When exposed to ultraviolet radiation, through a photographically reduced transparency, the resist "cross-links" or polymerizes in the areas that are struck by ultraviolet radiation (Fig. 4). The image formed by the ultraviolet radiation and defined by the clear areas of the transparency is insoluble in the developing bath. The opaque areas of the transparency act as a mask and allow those portions that have received no exposure to be dissolved in the developer. The soluble portions wash away and leave a tough, chemically resistant image in minute relief on the surface. This image acts as a clearly defined mask for etching.

i. Artwork - In order to produce a part by the photofabrication process a master or working transparency of the desired pattern will be needed. This is obtained by first drafting the pattern, usually somewhat larger than its final size, and then photographically reducing this master artwork to the required size. In this way, drafting errors are reduced, and the pattern on the transparency has greater accuracy.

The pattern of reinforcements was drawn by hand on drafting paper twice the actual size of the finished grid.

ii. Photography - One of the most important steps in photofabrication is photography of the artwork, since the quality of the finished part is directly dependent on the quality of the transparency used to produce the part.

A transparency used as a working master for photofabrication must possess two attributes: sharpness and density. Additionally, the clear areas of the transparency must offer a minimum density in order to effect a complete photoresist exposure.

Maximum sharpness on a transparency is needed because of the extremely high resolution capabilities of KPR. The transparency must also have sufficient high density in opaque areas to prevent exposure of the photoresist in the areas that are to be developed away. A photoresist image that has been exposed to a transparency low in density will be "fogged". This means that there is not only exposed resist in the pattern area but also partially-exposed resist on the surrounding portions of the surface. Processing of an image in such condition is very difficult and yields unsatisfactory parts.

As mentioned before, photographic reduction of the artwork is used. Thus, the camera which is used must have good characteristics for photographic reduction. Furthermore, the film must also have high contrast characteristics. To satisfy these requirements, a telephoto lens on a bellows-type camera and Kodak Ortho Film, Type 3, were used for this work. The camera back, lens board, and copy board were, of course, set up parallel to one another.

iii. Coating and Exposure of Photoresist - In order to perform satisfactorily, Kodak photosensitive resists must be applied to thoroughly clean surfaces. Resist failures, when they occur, are usually traceable to poor or inadequate cleaning techniques.

Therefore, the surface of the brass shim used was cleaned with emery paper of grit 600 and acetone. Then it was washed in running water and was oven dried. After this preparation, KPR was applied to the surface.

Several methods of applying photoresist are possible. These include spraying, whirling, dipping, flowing and roller coating. All of these systems have advantages and disadvantages, and there are specific areas in which each functions best. In this investigation, the whirling method, described below, was used.

There are two kinds of whirler coating methods: low-speed (about 75 rpm) and high-speed (from $200 \sim 700$ rpm).

A low-speed whirler coating of full strength KPR without forced drying, will yield a coating of average thickness that is capable of good resolution and chemical resistance.

A high-speed whirler coating will give a very thin resist coating that is capable of maximum resolution. Coating thicknesses obtained by this method are excellent from a resolution standpoint and will produce extremely fine detail. Because these coating thicknesses are generally in the micron range, a particular coating thickness or a particular resist dilution is determined empirically.

The normal procedure with whirling devices is to place a flowcoated plate on the whirler and turn the equipment on. Applying the coating while the plate is whirling should be avoided as incomplete coverage will usually result.

In this research, the photoresist (10 parts resist, $2 \sim 3$ parts KOR Thinner) was applied to the surface of the brass shim with cheesecloth and then a high speed whirler was used for a few seconds. After this, the photoresist coated brass shim was dried at room temperature for about 20 minutes and then the other surface of the brass shim was coated in the same way.

Baking the photoresist layer prior to exposure is often helpful for a particular photofabrication process. The purpose of the prebake is to remove any residual photoresist solvent that has not been eliminated by air drying. Therefore, the photoresist coated brass shim was prebaked in an oven for 10 minutes at 80°C.

Kodak photoresists are sensitive to a particular range of the light spectrum. The peak spectral sensitivities of these resists are in the near ultraviolet, between 280 and 550 millimicrons.

Typical light sources for KPR include carbon-arc lamps, highpressure mercury-vapor lamps, and so on. In fact, any high-energy light source that is rich in the near-ultraviolet region of the spectrum can be used. Here two 275w sunlamps, shown in Fig. 5, were used as the light source.

Optimum exposure levels giving the highest resolution were established in the following manner. The resist-coated plate was illuminated

for various periods while exposed parts of the plate were covered with an opaque mask. The plate was processed and examined to determine the acceptable exposure times.

With two sunlamps as the light source, the optimum exposure time was found to be between 4 and 9 minutes. This wide range of exposure times depended on the freshness of the photoresist and the conditions of the transparency.

iv. Development of Exposed Plates - Exposed plates were developed in a tray. Care must be exercised with double-sided work, as there is a danger that one side of the image may be scored by the bottom of the tray. To avoid such damage, the exposed, coated brass shims were developed with very gentle agitation. Even so, small spots of damage appeared on some shims. When small damage occurred on the back surface it was covered with an adhesive tape before the etching.

After completing the development, the surface was washed in running water, dyed with a Kodak Photo Resist Dye for 30 seconds, and was washed again. Finally, plates were postbaked for 10 minutes at 120°C.

v. Etching - The basic problem of etching is that reaction products (as a result of the chemical dissolution of metal) are not carried away from the surface of the brass rapidly. These products then concentrate on the surface and often retard the action of the etching bath. As these products build up, the etchant seeks more metal to dissolve, and eventually starts to etch the metal under the resist as shown in Fig. 6. This, of course, causes a poor etch factor which is defined as the depth of etch divided by the amount of sideward growth observed

when a line is etched. It is calculated for one side of a line only.

A way around the problems of etching is to provide agitation in the etching solution. This helps to remove reaction products, and to improve etch factors.

Agitation may be provided by either stirring the etching bath, bubbling air through the solution, or by spraying the etchant on the surface. In this experiment the brass shims were etched with a ferric chloride solution in a hand agitated glass tray. With this technique the reaction products cannot be removed well from the surface.

In order to solve this problem, the surface of the brass shim was washed several times with running water during the etching procedure. This provided a fresh surface for the etchant to act upon and reduce etching time and severe undercutting of the image. The frequency of surface washing depended on the thickness of brass shim and the required accuracy of reinforcement.

In addition, to reduce etching time, the etchant was heated to about 55°C.

Etching time was not constant, since it depends on the freshness of the solution, agitation and temperature. For the 0.005 inch thick brass shim, the etching time was about $60 \sim 90$ minutes including the time of about 15 surface washings.

3.3 Specimen Geometry and Photoelastic Test Procedure

Reinforcements following the pattern of the stress trajectories for an infinite plate with a hole under an uniaxial tensile load were

constructed as described in sections 3.1 and 3.2. Composite specimens were then made by sandwiching the brass shim reinforcement between two birefringent plates of epoxy resin (Photolastic PS-2C). The thickness of the brass shim, i.e., the thickness of reinforcement, was 0.005 in. while the thickness for PS-2C was 0.040 in. each.

0.005 in. brass shim is relatively thick for the photofabrication method, and hence it was difficult to obtain a good etch factor. Therefore, the line width of the reinforcements was not exactly constant. These average widths of lines are shown in Table 1 in Chapter 4.

Epoxy resin PMC-1 was used as the bonding cement. After gluing a reinforcement and two epoxy resin plates together, the specimen was machined and a hole was milled at its center. Though the stress trajectories were computed for an infinite plate with 0.5 in. diameter hole, the actual hole size was 0.436 in. in order to leave some photoelastic material inside the reinforcement. The specimen geometries are shown in Figs. 7 and 8. After finishing the examinations of the specimens with 0.436 in. diameter holes, the hole size was enlarged to 0.535 in., in the specimens A and B.

In specimens A and C (Figs. 7 and 8) the reinforcement follows lines corresponding to the stress trajectories for an infinite plate with 0.436 in. hole. Specimens B and D have straight line reinforcement and specimen P is a plane specimen, i.e., no reinforcement. A prime indicates the specimens with 0.535 in. diameter holes.

The specimens were then placed in the field of a circularly polarized, point light source, polariscope. The load frame is shown in Fig. 9. The applied load was determined from the displacement of

the specimen, which was measured by a dial gage.

The light source was a white, mercury vapor lamp using an appropriate green filter to produce monochromatic light. The resulting fringe patterns were photographed using both light and dark field, and the Tardy method to determine the intermediate fringes between fringes of light and dark field and to determine the fringes at the edges. In order to ascertain the cupic point of each specimen, 0° isoclinic fringe patterns were also photographed.

Fringe patterns were photographed with a telephoto lens on a bellowstype camera using Kodak Contrast Process Ortho 4" x 5" film sheets. Negatives were printed on a high contrast paper. The fringe pattern was enlarged to approximately four times the actual size of the specimen. The use of both high contrast film and paper aided significantly in reducing the thickness of the fringes, thus making distance measurements of fringe center lines from the edge of the hole more accurate. Sample photographs are shown in Figs. 10 to 13.

It is well known that the stress optic relationship is given by

$$\sigma_1 - \sigma_2 = \frac{\mathrm{fn}}{\mathrm{t}} , \qquad (3-17)$$

where σ_1 and σ_2 are principal stresses, f is the material fringe value, n is the fringe order, and t is the thickness of the specimen. Since σ_2 equals zero at the edge of the hole, Eq. (3-17) can be simplified to

$$\sigma_1 = \frac{\mathrm{fn}}{\mathrm{t}} \,. \tag{3-18}$$

The stresses at the edge of the hole for each specimen was calculated

using Eq. (3-18). From which then the stress concentration factors K_t were determined using Eq. (1-2).

The material fringe values f for PS-2C and for the reinforced materials were determined by the calibration method [22], [23] with tensile specimens. These values are shown in Table 1 in Chapter 4.

4. RESULTS AND DISCUSSION

The differences of principal stresses, $\sigma_1 - \sigma_2$, on the transverse axis of symmetry through a central circular hole are measured as mentioned above and are plotted in Figures 14 to 20. The principal stresses, σ_1 and σ_2 , are also determined by a slope equilibrium (rapid) method [24], which is based on the Lamé-Maxwell equations of equilibrium and Mesnager's theorem, and are illustrated in the same Figures 14 to 20. The stress concentration factors K_t and all other pertinent data are recorded in Table 1.

Figures 14 to 20 show no significant differences between the shapes of curves for the different specimens.

On the other hand, considering specimens with the same hole diameter (0.436 in.), that is, specimens A, B, C, D and P, stress concentration factors for the reinforced specimens are found to be smaller than that of the plane specimen P. Specimen C (analogue) had a minimum value of K_t with a 19% reduction of the stress concentration factor compared to the plane specimen P. Specimens A and D showed a 12% reduction. On the other hand, specimen B which had the least amount of straight reinforcement exhibited only 5% reduction of the stress concentration factor.

As shown in Table 1, volume fractions were 0.022, 0.016, 0.023 and 0.020 for specimens A, B, C and D, respectively. While these volume fractions are small in comparison with those of structurally useful composite materials, a 19% reduction in the stress concentration factor

for specimen C, with analogue reinforcement, shows a significant alleviation of the stress concentration around the hole.

Though the volume fraction of the reinforcement in specimen A (analogue) is 37% larger than that of specimen B (straight), the stress concentration factor is reduced by only 8% in comparison with specimen B. On the other hand, the value of K_t for specimen C (analogue) with 15% larger volume fraction was reduced 8.5% with respect to the specimen D (straight).

For the two specimens with analogue reinforcement, 4.5% increase of the volume fraction caused 8% reduction in the stress concentration factor (A vs. C). In the case of the two straight reinforcements, 25% increase of the volume fraction caused 8% reduction in the stress concentration factor (B vs. D). That is, the increases of 4.5% and 25%, in volume fraction, introduced the same reduction, 8%, in the stress concentration factor. In order to explain this difference, the distance from the edge of the hole to the inner edge of the nearest reinforcing line will be examined.

The distances from the edge of the hole to the inner edge of the nearest reinforcing line are shown in Table 1. The differences between specimens are appreciable. The value of K_t of specimen C was reduced 8% with 34% decrease of the distance from the edge of the hole to the nearest reinforcing line and 4.5% increase of the volume fraction (C vs. A). On the other hand, the value of K_t of specimen D was decreased 8% with 2% increase of the distance from the edge of the hole to the nearest reinforcing line and 25% increase of the volume fraction (D vs. B).

From the above discussion, it may be deduced that the larger volume fraction gives rise to a smaller value of the stress concentration factor. It may also be concluded that the shorter the distance from the edge of the hole to the nearest reinforcing line the smaller the value of the stress concentration factor.

The distance from the edge of the hole to the nearest reinforcing line for specimen A (analogue) was 3.2 times larger than for specimen B (straight), and in specimen C, 2.1 times larger than in specimen D. Though the analogue reinforced plates have larger distances from the edge of the hole to the nearest reinforcing line, the value of K_t for specimens A and C is 8% and 8.5% smaller than for specimens B and D, respectively. Therefore, if these distances and the volume fractions were the same for each specimen, the stress concentration factors for the specimens with analogue reinforcement would be reduced much more than for plates with straight reinforcement.

Specimens A' and B' with 0.535 in. diameter holes were examined to determine the effect of the distance from the edge of the hole to the nearest reinforcing line. The values of K_t for specimens A' and B' were 3.08 and 3.51 respectively as shown in Table 1, and the value of K_t for specimen B' is 14% greater than that of the specimen A'. These values increased more rapidly than that of the theoretical solution for an infinite, homogeneous, isotropic plate (see Fig. 21). Furthermore, the stress concentration factor of specimen B' was farger than the theoretical value.

As mentioned in the previous chapter, the holes in specimens A and B were enlarged to 0.535 in. diameter (A^{+}, B^{+}) after they were tested with the original 0.436 in. diameter hole. Residual stresses which could not be ignored were found around the holes. The steep increase, therefore, may be due to the influence of these residual stresses.

At the same time, the value of K_t for specimen B' increased more rapidly than for specimen A'. As shown in Table 1, the distances from the edge of the hole to the nearest reinforcing line are 0.0114 and 0.0883 in. respectively for specimens A' and B'. The distance for specimen B' is 7.75 times larger than for specimen A'. Therefore, the steeper increase of K_t for B' may be contributed to the large distance between the edge of the hole and the nearest reinforcing line in addition to the influence of the residual stresses.

A comparison of these stress concentration factors with the experimental results of Daniel and Rowlands is shown in Figure 21. In this figure, the present experimental results are denoted by small circles and curve (1) represents the results for $[90/0/90/0]_{\rm S}$ 7-ply glass-epoxy laminates as determined by Daniel and Rowlands. The numerical value of the stress concentration factor for an isotropic material as a function of hole size is illustrated by the solid line [2]. The theoretical stress concentration factor for an anisotropic material, determined by Daniel and Rowlands and denoted by an asterisk, was computed using the following expression:

$$K_{t} = 1 + \sqrt{2(\sqrt{\frac{E_{L}}{E_{T}}} - v_{LT}) + \frac{E_{L}}{G_{LT}}}$$
 (4-1)

where E_L , E_T = elastic moduli in the longitudinal and transverse directions respectively

- v_{1T} = Poisson's ratio
- GLT = shear modulus, related to the values of elastic moduli and Poisson's ratio by the relation

$$\frac{1}{G_{LT}} = \frac{4}{E_{45}} - \frac{1 - 2v_{LT}}{E_{L}} - \frac{1}{E_{T}}$$

According to curve 1, the stress concentration factor for a 0.436 in. hole is about 4.0. This value is quite large in comparison with the theoretical value of 3.19 for an isotropic plate. On the other hand, every experimental value measured in the present investigation was less than the theoretical value for an isotropic plate (with the exception of B'). The specimens of Daniel and Rowlands were $[90/0/90/\overline{0}]_{s}$ glass-epoxy composites with a volume fraction of glass-fibers $v_{f} = 0.45$, while the volume fractions in the present investigation are about 0.02.

As mentioned in Chapter 2, Hyman reported tensile test results on fiber reinforced plates with circular holes. In his investigation, he found that the drilled hole had more of a weakening effect on bidirectional composite plates than it did on unidirectional plates (Group 1B vs. Group 1C, see Fig. 3).

Therefore, even if the differences in reinforcements are considered, it is interesting to note these large differences in stress concentration factors between the Daniel and Rowlands' results and the present results together with Hyman's tests.

As mentioned in Chapter 2, Suzuki [13] measured the stress concentration factors in an infinite, aluminum plate with a hole reinforced with various materials. His reinforcing rings are shown in Fig. 2(b). The comparison with one of his results for the case of $R_1/R_2 = 20/23$ is shown in Fig. 22. The curves (1), (2), (3) and (4) are the results for the case of aluminum, brass, copper and mild steel reinforcing rings, respectively. The present results are represented by small circles. The stress concentration factor of specimen C coincides with the case of $h_1/h_2 = 1.5$ for a mild steel reinforcing ring. For a reinforcing ring consisting of the same material as the plate, i.e., aluminum, the value of h_1/h_2 is about 2. If it is assumed that the thickness of the reinforcement in specimen C is equivalent to the thickness of a reinforcing ring, then the value of h_1/h_2 (total thickness of plate/ thickness of plastic) for specimen C becomes about 1.055. For this value of the parameter, the Suzuki's plate would have $K_t = 3$ while specimen C has a K_{t} value of 2.57. The situation between Suzuki's specimens and the specimens discussed here are, of course, quite different. But one may expect a large saving in thickness with analogue reinforcement and still obtain same stress concentration factor.

T	A	В	L	Ε	1

		A	В	C	D	Р	A ^s	Bı
Thickness	(in.)	0.097	0,097	0.098	0.101	0.047	0.097	0.097
Width	(in.)	1.903	1.901	1.907	1.905	1.898	1.905	1.901
Hole Diameter	(in.)	0.436	0.436	0.436	0.436	0.436	0.535	0.535
Applied Load	(1b.)	240	240	240	240	180	228	228
Material Fring (psi-in./frin	e Value (f) ge)	75.2	75.2	75,2	75.2	58.7	75.2	75.2
Stress Concent Factor (K _t)	ration	2.80	3.04	2.57	2.81	3.19	3.08	3,51
Line Width of Reinforcement	(in.)	0.0255	0.0213	0.0140	0.0145	20 10	0.0244	0.0213
Volume Fractio	n (V _f)	0.022	0.016	0.023	0.020	ann 000-	0.022	0.016
Distance* (in	.)	0.0537	0.0167	0.0356	0.0170	au 14	0.0114	0.0883

*Distance: Distance from the edge of the hole to the nearest reinforcing line

5. CONCLUSIONS AND RECOMMENDATIONS

In spite of the small volume fraction used, considerable alleviation of the stress concentration factor was obtained with the use of analogue reinforcements. In these specimens, reinforcing lines coincide with the stress trajectories of an isotropic plate. Results were compared with those obtained on specimens containing straight, rectangulargrid type reinforcement. It was also observed that larger volume fraction resulted in a smaller stress concentration factor in both types of specimens. That is, the specimen with analogue reinforcement and the largest volume fraction had a smallest stress concentration factor, and the specimen containing straight reinforcement with the smallest volume fraction had the largest stress concentration factor. This suggests that analogue reinforcement with volume fractions of practical values will produce reasonable small stress concentration factors.

In closing, the author wishes to make the following recommendations for future experiments in this area.

- Tests should be performed with larger volume fractions, since the volume fraction of the reinforcement in the specimens used here was too small.
- (2) Experiments should also be performed on laminated composites where the reinforcement is arranged in an analogue pattern around the hole while it has a standard $[90/\overline{0}]_{c}$ configuration elsewhere.
- (3) Tests with several values of the ratio of a/b should be performed and should be compared with the well known values for an isotropic plate.

(4) In this investigation, the diameter of the hole for the calculation of the stress trajectories and the actual hole sizes used in the specimens were different in order to leave some birefringent material inside the reinforcement. To avoid this problem and to obtain more accurate data, a birefringent coating method, or a moiré technique may be considered in future experiments.

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Fig. 1. Stresses in Polar Coordinates around a Circular Hole for a Bar in Tension



Shimada, Ref. 11



Suzuki, Refs. 12 and 13



Seika, Ref. 14



Seika, Ref. 15

Fig. 2. Various Types of Reinforcing Rings





Fig. 3. Test Specimens of Hyman (Ref. 18)





Stock Coated with Photoresist



Transparency in plate on the surface



The photoresist receiving exposure



The exposed, developed photoresist layer

Fig. 4. Process of Photofabrication



Fig. 5. Apparatus for Exposure in Photofabrication







Fig. 6. Reaction Products in Etching Procedure





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Fig. 8. Photograph of Specimens A, B, C and D







*Dark field **Numbers denote fringe orders

Fig. 10. Fringe Pattern of Specimen A



*Dark field **Numbers denote fringe orders

Fig. 11. Fringe Pattern of Specimen B



*Dark field **Numbers denote fringe orders

Fig. 12. Fringe Pattern of Specimen C



*Dark field **Numbers denote fringe orders

Fig. 13. Fringe Pattern of Specimen D



Fig. 14. Stress Distributions in Specimen A



Fig. 15. Stress Distributions in Specimen B



Fig. 16. Stress Distributions in Specimen C



Fig. 17. Stress Distributions in Specimen D





Fig. 18. Stress Distribution in Specimen P





Fig. 19. Stress Distributions in Specimen A'



Dimensionless Distance from Hole, (y-a)/(b-a)

Fig. 20. Stress Distributions in Specimen B'



Fig. 21. Comparison with the Experimental Results of Daniel and Rowlands and with the Theoretical Value for an Isotropic Plate





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ALLEVIATION OF STRESS CONCENTRATION WITH ANALOGUE REINFORCEMENT

by

Toshiaki Chiba

(ABSTRACT)

In order to reduce the stress concentration around a hole in a plate, new, "analogue" reinforcements instead of reinforcing rings were used in this investigation. In two of these specimens, reinforcements with different volume fractions were arranged to coincide with the stress trajectories for an infinite plate with a hole under uniaxial tension. Two other specimens contained straight rectangular-grid type reinforcements with different volume fractions. These 0.005 in. thick brass reinforcements were made by using a photofabrication method. Specimens were then prepared by sandwiching these reinforcements between two epoxy resin plates. Plane specimens, i.e., without reinforcement, were also made of the same epoxy resin for comparison.

The stress concentrations at the edge of the hole under uniaxial tension were determined by photoelastic techniques. The measured stress concentration factors were compared with well known values for an infinite, isotropic, homogeneous plate containing a hole. Results were also compared with published data on $[90/0/90/\overline{0}]_{s}$ 7-ply laminate composite plates, and on plates strengthened with reinforcing rings.

A definite reduction in stress concentration was observed on specimens containing analogue reinforcement.